

## 30-01/A2C-AQSC

#### **Features**

- . High Flux Output.
- . Designed for High Current Operation.
- . Low Thermal Resistance.
- . Low Profile.
- . Packaged in Tubes for Use with Automatic Insertion Equipment.
- . The product itself will remain within RoHS compliant version.



### **Descriptions**

This revolutionary package design allows the light designer to reduce the number of LEDs required and provide a more uniform and unique illuminated appearance than with other LED solutions. This is possible through the efficient optical package design and high-current capabilities.

The low profile package can be easily coupled with reflectors or lenses to efficiently distribute light and provide the desired light appearance.

### **Applications**

- . Automotive Lighting
- . Electronic Signs and Signals
- . Special Lighting application

#### **Device Selection Guide**

	C	T Cala	
PART NO.	Material	Emitted Color	Lens Color
30-01/A2C-AQSC	A2C-AQSC AlGaInP		Water Clear

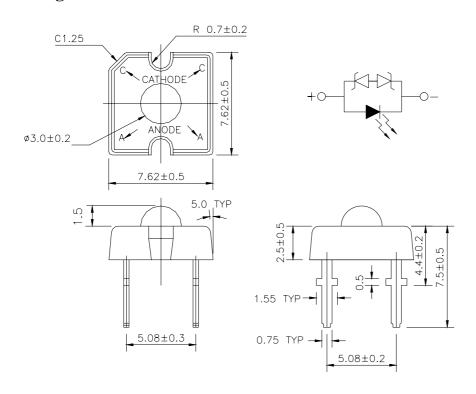
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Device number: DLE-300-059 Established date: 11-16-2005 Established by: Max Chen



## 30-01/A2C-AQSC

### **Package Dimensions**



**Notes:** 1.All dimensions are in millimeters

- 2.An epoxy meniscus may extend about 1.5mm(0.059") down the leads
- 3.Tolerances unless dimensions ±0.25mm

### **Absolute Maximum Ratings (Ta=25°C)**

Parameter	Symbol	Rating	Units
Continuous Forward Current	$I_{\mathrm{F}}$	70	mA
Peak Forward Current(Duty 1/10 @ 1KHZ)	$I_{FP}$	160	mA
Reverse Voltage	$V_R$	5	V
Operating Temperature	$T_{opr}$	-40 ~ +100	$^{\circ}\!\mathbb{C}$
Storage Temperature	$T_{stg}$	-40 ~ +100	$^{\circ}\mathbb{C}$
Soldering Temperature(T=5 sec)	$T_{sol}$	260 ± 5	$^{\circ}\mathbb{C}$
LED Junction Temperature	$T_{j}$	125	$^{\circ}\mathbb{C}$
Power Dissipation	P <sub>d</sub>	220	mW
Electrostatic Discharge	ESD	4000	V

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## **Electro-Optical Characteristics (Ta=25°C)**

Parameter	Symbol	Min.	Тур.	Max.	Condition	Unit
Total Flux	Фv	3600	5100		I <sub>F</sub> =70mA	mlm
Viewing Angle	2 \theta 1/2		70		I <sub>F</sub> =70mA	deg
Peak Wavelength	λр		621		I <sub>F</sub> =20mA	nm
<b>Dominant Wavelength</b>	λd		615		I <sub>F</sub> =20mA	nm
Spectrum Radiation Bandwidth	Δλ		18		I <sub>F</sub> =20mA	nm
Forward Voltage	VF		2.6	3.1	I <sub>F</sub> =70mA	V
Zener Reverse Voltage	Vz	5.8			Iz=5mA	V
Reverse Current	IR			10	V <sub>R</sub> =5V	uA

#### Rank

30-01/A2C-AQSC			
	(1)	(2)	(3)

( ) ( ) (-)								
	(1) VF(V)	١	(2) λ d(nm)		(3) Φv(mlm)			
Bin	Min	Max	Bin	Min	Max	Bin	Min	Max
3	2.10	2.30	6	610.0	613.5	Q	3600	4500
4	2.30	2.50	7	613.5	617.0	R	4500	5650
5	2.50	2.70	8	617.0	620.0	S	5650	7150
6	2.70	2.90						
7	2.00	3 10	]					

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<sup>\*</sup>Measurement Uncertainty of Forward Voltage: ±0.1V

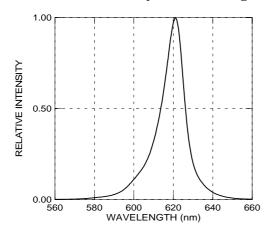
<sup>\*</sup>Measurement Uncertainty of Luminous Intensity: ±15%



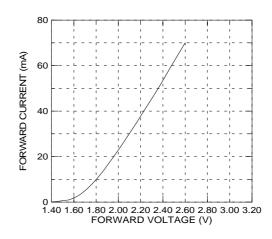
## 30-01/A2C-AQSC

## **Typical Electro-Optical Characteristics Curves**

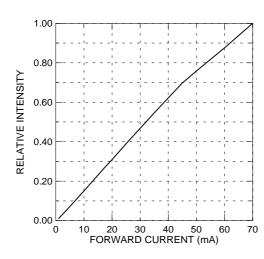
## Relative Intensity vs. Wavelength



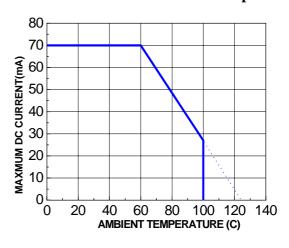
#### Forward Current vs. Forward Voltage



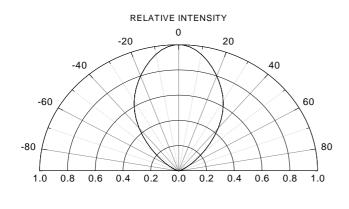
#### **Relative Intensity vs. Forward Current**



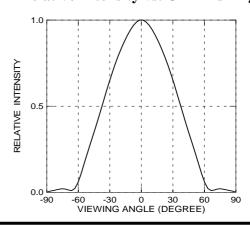
Forward Current vs. Ambient Temp.



#### Relative Intensity vs. Angle Dispacement



Relative Intensity vs. Off Axis Angle



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## 30-01/A2C-AQSC

### **Label Form Specification**

CPN: Customer's Production Number

P/N : Production Number QTY: Packing Quantity

CAT: Ranks of Flux and Forward Voltage

HUE: Ranks of Wavelength

**REF:** Reference

LOT No: Lot Number

MADE IN TAIWAN: Production Place

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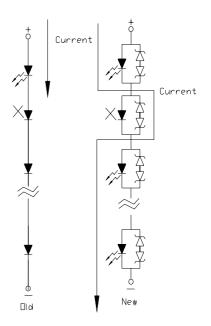
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#### **Notes**

- 1. Above specification may be changed without notice. EVERLIGHT will reserve authority on material change for above specification.
- 2. When using this product, please observe the absolute maximum ratings and the instructions for using outlined in these specification sheets. EVERLIGHT assumes no responsibility for any damage resulting from use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets.
- These specification sheets include materials protected under copyright of EVERLIGHT corporation. Please don't reproduce or cause anyone to reproduce them without EVERLIGHT's consent.
- 4. Below the zener reference voltage Vz, all the current flows through LED and as the voltage rises to Vz, the zener diode "breakdown." If the voltage tries to rise above Vz current flows through the zener branch to keep the voltage at exactly Vz.
- 5. When the LED is connected using serial circuit, if either piece of LED is no light up but current can't flow through causing others to light down. In new design, the LED is parallel with zener diode. if either piece of LED is no light up but current can flow through causing others to light.



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#### 6. Soldering Condition

Careful attention should be paid during soldering. When soldering, leave more then 3mm from solder joint to case, and soldering beyond the base of the tie bar is recommended.

Avoiding applying any stress to the lead frame while the LEDs are at high temperature particularly when soldering.

Recommended soldering conditions:

Hand	Soldering	DIP Soldering		
Temp. at tip of iron	400°C Max. (30W Max.)	Preheat temp.	100°C Max. (60 sec Max.)	
Soldering time	3 sec Max.	Bath temp.	265 Max.	
Distance	3mm Min.(From solder joint	Bath time.	5 sec Max.	
	to case)			
		Distance	3mm Min.	

EVERLIGHT ELECTRONICS CO., LTD.

Office: No 25, Lane 76, Sec 3, Chung Yang Rd,

2267-6306

Fax: 886-2267-6244, 2267-6189,

Tel: 886-2-2267-2000, 2267-9936

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